

MC100LVEL32

3.3V ECL ÷2 Divider

The MC100LVEL32 is an integrated ÷2 divider. The LVEL32 is functionally identical to the EL32, but operates from a 3.3 V supply.

The reset pin is asynchronous and is asserted on the rising edge. Upon power-up, the internal flip-flop will attain a random state; the reset allows for the synchronization of multiple LVEL32's in a system.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μ F capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

- 510 ps Propagation Delay
- 2.6 GHz Typical Maximum Frequency
- ESD Protection: Human Body Model; >4 KV,
Machine Model; >200 V
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: $V_{CC} = 3.0$ V to 3.8 V
with $V_{EE} = 0$ V
- NECL Mode Operating Range: $V_{CC} = 0$ V
with $V_{EE} = -3.0$ V to -3.8 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 V-0 @ 0.125 in,
Oxygen Index: 28 to 34
- Transistor Count = 111 devices



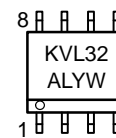
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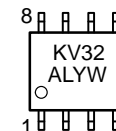
MARKING DIAGRAMS*



**SOIC-8
D SUFFIX
CASE 751**



**TSSOP-8
DT SUFFIX
CASE 948R**



A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

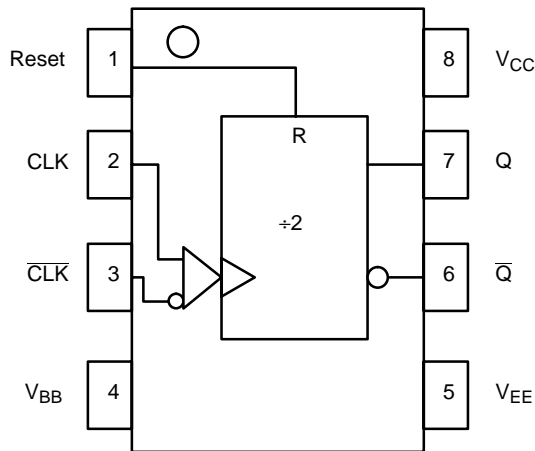
*For additional information, see Application Note
AND8002/D

ORDERING INFORMATION

Device	Package	Shipping†
MC100LVEL32D	SO-8	98 Units / Rail
MC100LVEL32DR2	SO-8	2500 / Reel
MC100LVEL32DT	TSSOP-8	98 Units / Rail
MC100LVEL32DTR2	TSSOP-8	2500 / Reel

†For information on tape and reel specifications,
including part orientation and tape sizes, please
refer to our Tape and Reel Packaging Specifications
Brochure, BRD8011/D.

MC100LVEL32



PIN DESCRIPTION

PIN	FUNCTION
CLK*, CLK**	ECL Differential Clock Inputs
Q, Q	ECL Differential Data ÷2 Outputs
Reset	ECL Asynch Reset
V _{BB}	Reference Voltage Output
V _{CC}	Positive Supply
V _{EE}	Negative Supply

*Pin will default low when left open, per internal 75 K pull-down to V_{EE}.

** Pin will default to V_{CC}/2 when left open per internal 75 KΩ pull-down to V_{EE} and 75 KΩ pull-up to V_{CC}.

Figure 1. LOGIC DIAGRAM AND PINOUT ASSIGNMENT

MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		–8 to 0	V
V _I	PECL Mode Input Voltage	V _{EE} = 0 V	V _I ≤ V _{CC}	6 to 0	V
V _I	NECL Mode Input Voltage	V _{CC} = 0 V	V _I ≥ V _{EE}	–6 to 0	V
V _I	PECL Mode Input Voltage	V _{EE} = 0 V	V _I ≤ V _{CC}	6 to 0	V
V _I	NECL Mode Input Voltage	V _{CC} = 0 V	V _I ≥ V _{EE}	–6 to 0	V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			–40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ _{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	8 SOIC	41 to 44 ± 5%	°C/W
θ _{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	8 TSSOP	41 to 44 ± 5%	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If stress limits are exceeded device functional operation is not implied, damage may occur and reliability may be affected. Functional operation should be restricted to the Recommended Operating Conditions.

MC100LEVEL32

LVPECL DC CHARACTERISTICS $V_{CC}=3.3\text{ V}$; $V_{EE}=0.0\text{ V}$ (Note 1)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		29	35		29	35		31	36	mA
V_{OH}	Output HIGH Voltage (Note 2)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V_{OL}	Output LOW Voltage (Note 2)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V_{IH}	Input HIGH Voltage (Single-Ended)	2135		2420	2135		2420	2135		2420	mV
V_{IL}	Input LOW Voltage (Single-Ended)	1490		1825	1490		1825	1490		1825	mV
V_{BB}	Output Voltage Reference	1.92		2.04	1.92		2.04	1.92		2.04	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 6) $V_{PP} < 500\text{ mV}$ $V_{PP} \geq 500\text{ mV}$	1.2		3.1	1.1		3.1	1.1		3.1	V
		1.4		3.1	1.3		3.1	1.3		3.1	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current $\frac{\text{CLK}}{\text{CLK}}$	0.5			0.5			0.5			μA
		-600			-600			-600			μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained.

1. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $\pm 0.3\text{ V}$.
2. Outputs are terminated through a 50 ohm resistor to $V_{CC}-2\text{ volts}$.
3. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PPmin} and 1 V.

LVNECL DC CHARACTERISTICS $V_{CC}=0.0\text{ V}$; $V_{EE}=-3.3\text{ V}$ (Note 4)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		29	35		29	35		31	36	mA
V_{OH}	Output HIGH Voltage (Note 5)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V_{OL}	Output LOW Voltage (Note 5)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V_{IH}	Input HIGH Voltage (Single-Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V_{IL}	Input LOW Voltage (Single-Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V_{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 6) $V_{PP} < 500\text{ mV}$ $V_{PP} \geq 500\text{ mV}$	-2.1		-0.2	-2.1		-0.2	-2.1		-0.2	V
		-1.9		-0.2	-1.9		-0.2	-1.9		-0.2	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current $\frac{\text{CLK}}{\text{CLK}}$	0.5			0.5			0.5			μA
		-600			-600			-600			μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained.

4. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $\pm 0.3\text{ V}$.
5. Outputs are terminated through a 50 ohm resistor to $V_{CC}-2\text{ volts}$.
6. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PPmin} and 1 V.

MC100LEVEL32

AC CHARACTERISTICS $V_{CC}=3.3\text{ V}$; $V_{EE}=0.0\text{ V}$ or $V_{CC}=0.0\text{ V}$; $V_{EE}=-3.3\text{ V}$ (Note 7)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{\max}	Maximum Toggle Frequency	2.2	2.5		2.4	2.6		2.6	2.8		GHz
t_{PLH} t_{PHL}	Propagation Delay CLK to Q (Diff) CLK to Q (S.E.) Reset to Q	350 300 440	500 500 555	530 580 640	370 320 450	510 510 540	550 600 650	410 360 480	540 540 580	590 640 680	ps
t_{RR}	Reset Recovery	175	50		175	50		175	50		ps
t_{PW}	Minimum Pulse Width Reset	500	300		500	300		500	300		ps
t_{JITTER}	Random Clock Jitter (RMS)		2.0			2.0			2.0		ps
V_{PP}	Input Swing (Differential Swing) (Note 8)	150		1000	150		1000	150		1000	mV
t_r t_f	Output Rise/Fall Times Q (20% – 80%)	120	225	320	120	225	320	120	225	320	ps

7. V_{EE} can vary $\pm 0.3\text{ V}$.

8. $V_{PP}(\min)$ is input swing measured single-ended on each input in differential configuration.

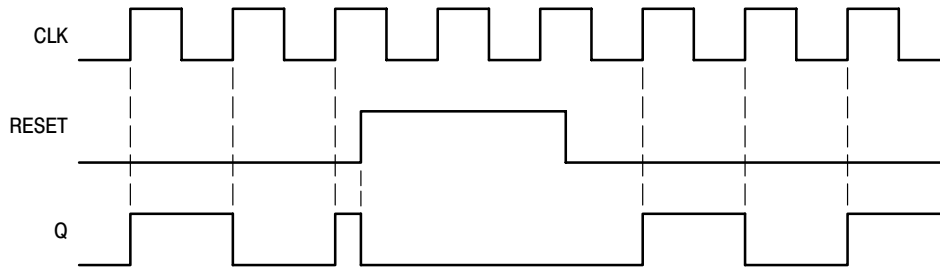


Figure 1. Timing Diagram

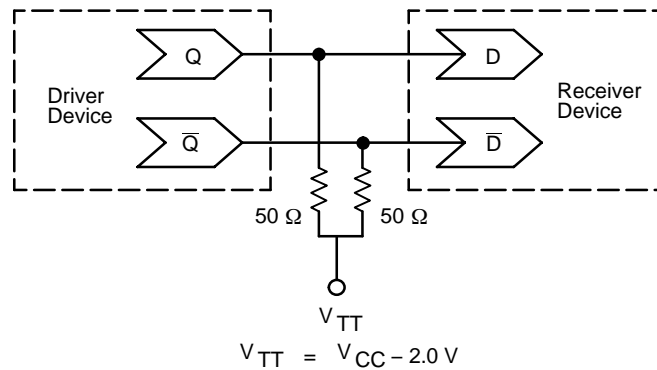


Figure 2. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020 – Termination of ECL Logic Devices.)

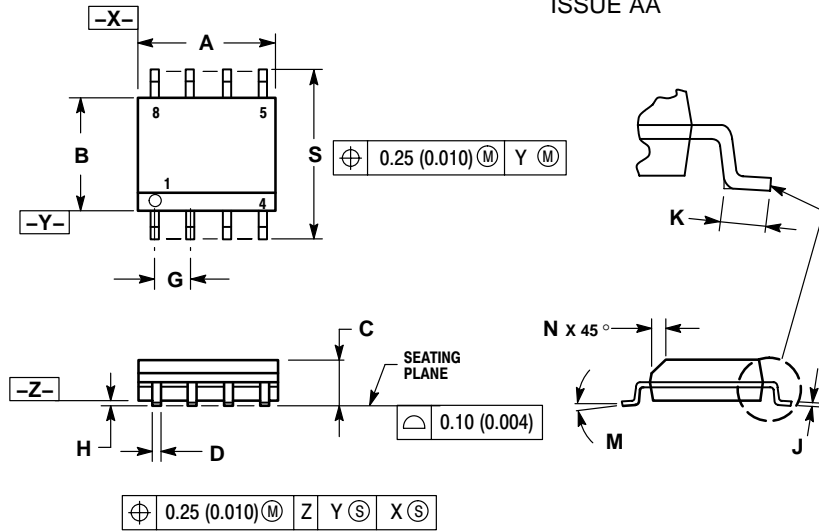
Resource Reference of Application Notes

- AN1404** – ECLinPS Circuit Performance at Non-Standard V_{IH} Levels
- AN1405** – ECL Clock Distribution Techniques
- AN1406** – Designing with PECL (ECL at +5.0 V)
- AN1503** – ECLinPS I/O SPICE Modeling Kit
- AN1504** – Metastability and the ECLinPS Family
- AN1560** – Low Voltage ECLinPS SPICE Modeling Kit
- AN1568** – Interfacing Between LVDS and ECL
- AN1596** – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
- AN1650** – Using Wire-OR Ties in ECLinPS Designs
- AN1672** – The ECL Translator Guide
- AND8001** – Odd Number Counters Design
- AND8002** – Marking and Date Codes
- AND8020** – Termination of ECL Logic Devices

MC100LVEL32

PACKAGE DIMENSIONS

SOIC-8 D SUFFIX PLASTIC PACKAGE CASE 751-07 ISSUE AA

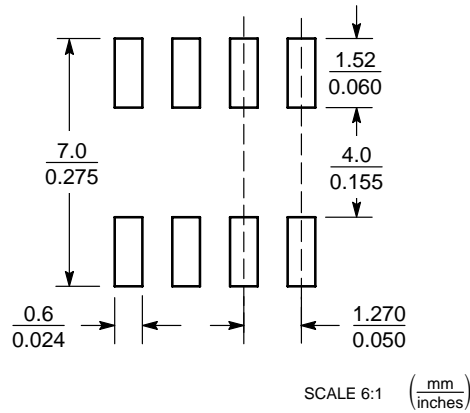


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

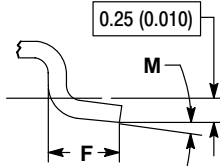
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT



SOIC-8


TSSOP-8
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948R-02
ISSUE A



DETAIL E

- | | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| A | 2.90 | 3.10 | 0.114 | 0.122 |
| B | 2.90 | 3.10 | 0.114 | 0.122 |
| C | 0.80 | 1.10 | 0.031 | 0.043 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.40 | 0.70 | 0.016 | 0.028 |
| G | 0.65 BSC | | 0.026 BSC | |
| K | 0.25 | 0.40 | 0.010 | 0.016 |
| L | 4.90 BSC | | 0.193 BSC | |
| M | 0° | 6° | 0° | 6° |

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